

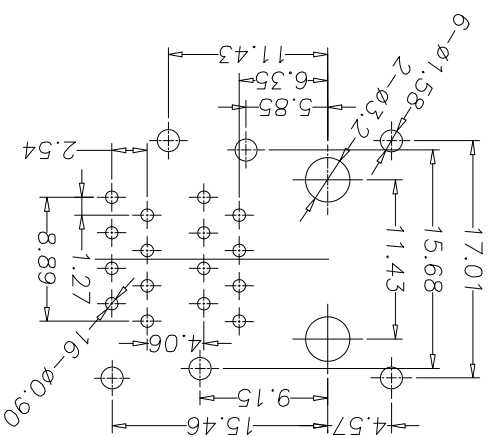
NOTES:

MATERIAL:

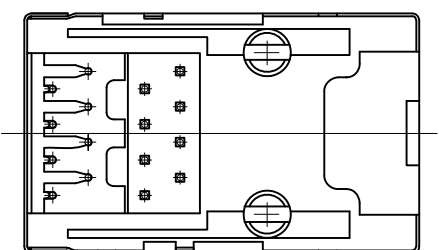
- 1. HOUSING MATERIAL :GLASS FILLED POLYESTER(U94V-0),
- 2. CONTACT MATERIAL :PHOSPHOR BRONZE $\phi 0.46\text{mm}$
OR T=0.35 (C5100).
- 3. PLATING :GOLD PLATING OVER NICKEL.
- 4. SHIELD COPPER ALLOY 0.20mm THICKNESS PLATING NI.

ELECTRICAL:

- 1. VOLTAGE RATING :125 VAC RMS.
 - 2. CURRENT RATING :1.5 AMP.
 - 3. CONTACT RESISTANCE :30 MILLIOHMS MAX.
 - 4. INSULATION RESISTANCE :500 MEGOHMS MIN @ 500V DC.
 - 5. DIELECTRIC WITHSTANDING MECHANICAL RESISTANCE :1000V AC RMS 50HZ. 1MIN.
 - 1. DURABILITY :750 CYCLES MIN.
 - 2. PCB RETENTION PRE-SOLDER :1 LB MIN.
- ENVIRONMENTAL:
- 2. OPERATION : -40°C TO +85°C.
: 0°C TO 70°C
- MATES WITH MODULAR PLUG CONFORMING TO
FCC PART 68,SUBPART F.



PC Board Layout



APPROVED:	DATE:				
CHECKED:	DATE:				
DRAWN:	DATE:	TITLE: C			
LYF	2010-05-08	PART. NO.	R-RJ45R08P-2007	深圳市灿科盟实业有限公司 CHANKEMENG INDUSTRY CO., LTD	
		UNIT	mm	SCALE	free
		FILE NO.	Chkmtw-RJ45-0039	REV.	HY04